

The RF MOSFET Line

RF Power Field Effect Transistors

N-Channel Enhancement-Mode Lateral MOSFETs

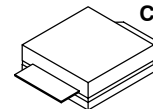
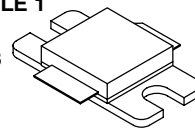
MRF18030ALR3
MRF18030ALSR3

Designed for GSM and EDGE base station applications with frequencies from 1.8 to 2.0 GHz. Suitable for FM, TDMA, CDMA and multicarrier amplifier applications. Specified for GSM 1805 - 1880 MHz.

- Typical GSM Performance:
Power Gain - 14 dB (Typ) @ 30 Watts
Efficiency - 50% (Typ) @ 30 Watts
- Internally Matched, Controlled Q, for Ease of Use
- High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 5:1 VSWR, @ 26 Vdc, 30 W Output Power
- Excellent Thermal Stability
- Low Gold Plating Thickness on Leads, 40μ" Nominal.
- in Tape and Reel. R3 Suffix = 250 Units per 32 mm, 13 inch Reel.

1.8 - 1.88 GHz, 30 W, 26 V
GSM/GSM EDGE
LATERAL N-CHANNEL
RF POWER MOSFETs

CASE 465E-04, STYLE 1
NI-400
MRF18030ALR3



CASE 465F-04, STYLE 1
NI-400S
MRF18030ALSR3

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	65	Vdc
Gate-Source Voltage	V _{GS}	-0.5, +15	Vdc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	83.3 0.48	Watts W/°C
Storage Temperature Range	T _{stg}	- 65 to +150	°C
Operating Junction Temperature	T _J	200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	R _{θJC}	2.1	°C/W

ESD PROTECTION CHARACTERISTICS

Test Conditions	Class
Human Body Model	2 (Minimum)
Machine Model	M3 (Minimum)

NOTE - **CAUTION** - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

ELECTRICAL CHARACTERISTICS (T_C = 25°C, 50 ohm system unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
----------------	--------	-----	-----	-----	------

OFF CHARACTERISTICS

Drain-Source Breakdown Voltage (V _{GS} = 0 Vdc, I _D = 20 μAdc)	V _{(BR)DSS}	65	—	—	Vdc
Zero Gate Voltage Drain Current (V _{DS} = 26 Vdc, V _{GS} = 0 Vdc)	I _{DSS}	—	—	1	μAdc
Gate-Source Leakage Current (V _{GS} = 5 Vdc, V _{DS} = 0 Vdc)	I _{GSS}	—	—	1	μAdc

ON CHARACTERISTICS

Gate Threshold Voltage (V _{DS} = 10 Vdc, I _D = 100 μAdc)	V _{GS(th)}	2	3	4	Vdc
Gate Quiescent Voltage (V _{DS} = 26 Vdc, I _D = 250 mAdc)	V _{GS(Q)}	2	3.9	4.5	Vdc
Drain-Source On-Voltage (V _{GS} = 10 Vdc, I _D = 1 Adc)	V _{DS(on)}	—	0.29	0.4	Vdc
Forward Transconductance (V _{DS} = 10 Vdc, I _D = 1 Adc)	g _{fs}	—	2	—	S

DYNAMIC CHARACTERISTICS

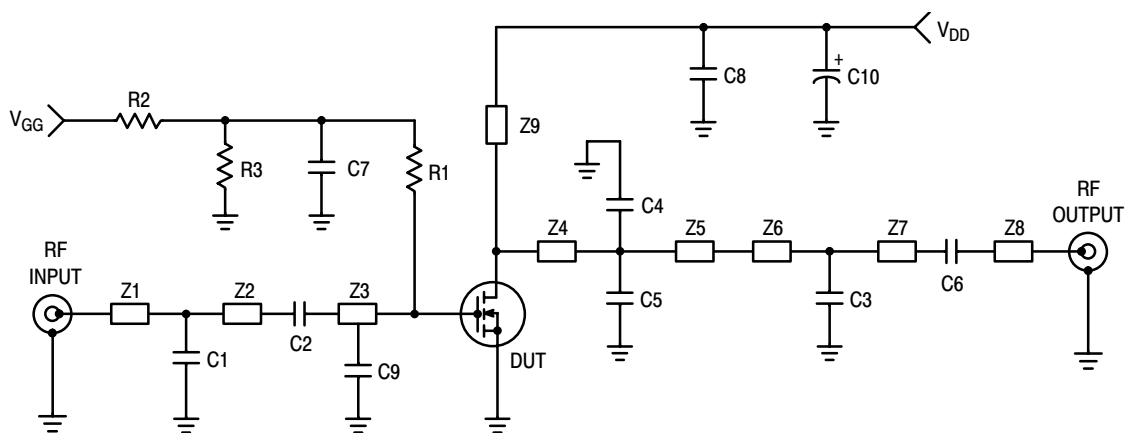
Reverse Transfer Capacitance (1) (V _{DS} = 26 Vdc ± 30 mV(rms)ac @ 1 MHz, V _{GS} = 0 Vdc)	C _{rss}	—	1.3	—	pF
--	------------------	---	-----	---	----

FUNCTIONAL TESTS (In Motorola Test Fixture) (2)

Output Power, 1 dB Compression Point (V _{DD} = 26 Vdc, I _{DQ} = 250 mA, f = 1805 - 1880 MHz)	P _{1dB}	27	30	—	Watts
Common-Source Amplifier Power Gain @ 30 W (V _{DD} = 26 Vdc, I _{DQ} = 250 mA, f = 1805 - 1880 MHz)	G _{ps}	13	14	—	dB
Drain Efficiency @ 30 W (V _{DD} = 26 Vdc, I _{DQ} = 250 mA, f = 1805 - 1880 MHz)	η	46.5	50	—	%
Input Return Loss @ 30 W (V _{DD} = 26 Vdc, I _{DQ} = 250 mA, f = 1805 - 1880 MHz)	IRL	—	-12	-9	dB
Output Mismatch Stress @ 30 W (V _{DD} = 26 Vdc, I _{DQ} = 250 mA, f ₁ = 1805 - 1880 MHz, VSWR = 5:1, All Phase Angles at Frequency of Tests)	Ψ	No Degradation In Output Power Before and After Test			

- (1) Part is internally matched both on input and output.
(2) Device specifications obtained on a Production Test Fixture.

Freescale Semiconductor, Inc.



C1	1.8 pF, 100B Chip Capacitor	Z1	0.874" x 0.087" Microstrip
C2	0.8 pF, 100B Chip Capacitor	Z2	1.094" x 0.087" Microstrip
C3	1.0 pF, 100B Chip Capacitor	Z3	0.257" x 0.633" Microstrip
C4, C5	1.2 pF, 100B Chip Capacitors	Z4	0.189" x 0.394" Microstrip
C6, C7, C8	8.2 pF, 100B Chip Capacitors	Z5	0.335" x 0.394" Microstrip
C9	0.3 pF, 100B Chip Capacitor	Z6	0.484" x 0.087" Microstrip
C10	220 μ F, 63 V Electrolytic Capacitor	Z7	0.877" x 0.087" Microstrip
R1	1.0 k Ω , 1/8 W Chip Resistor (0805)	Z8	0.366" x 0.087" Microstrip
R2, R3	10 k Ω , 1/8 W Chip Resistors (0805)	Z9	$\approx$ 0.600" x 0.087" Microstrip

Figure 1. 1805 - 1880 MHz Test Fixture Schematic

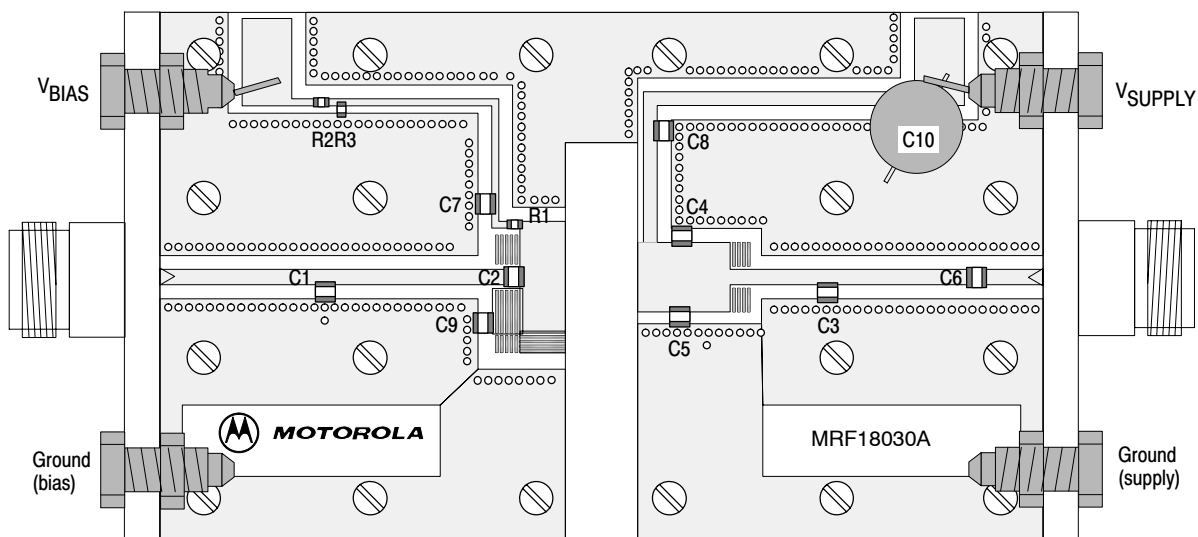


Figure 2. 1805 - 1880 MHz Test Fixture Component Layout

Freescale Semiconductor, Inc.

TYPICAL CHARACTERISTICS

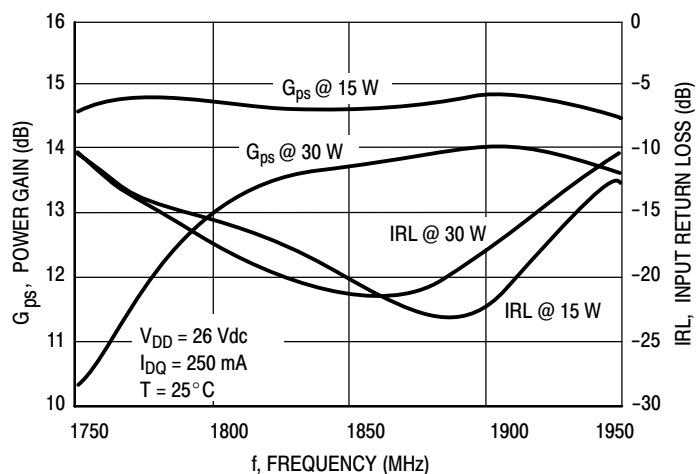


Figure 3. Wideband Gain and IRL at 30 W and 15 W Output Power

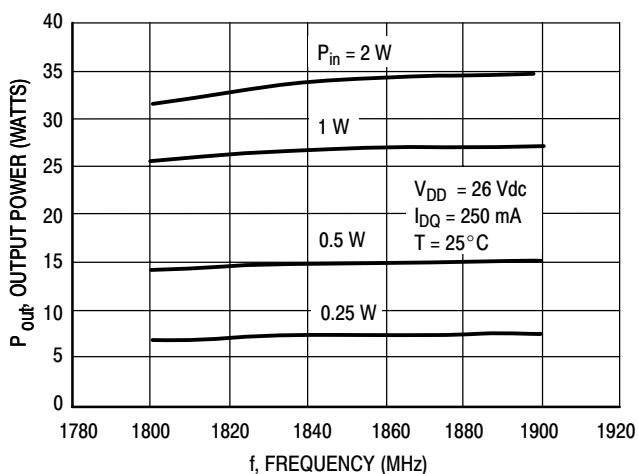


Figure 4. Output Power versus Frequency

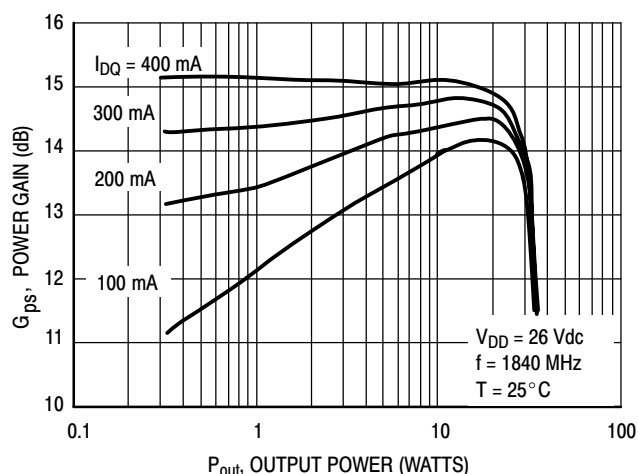


Figure 5. Power Gain versus Output Power

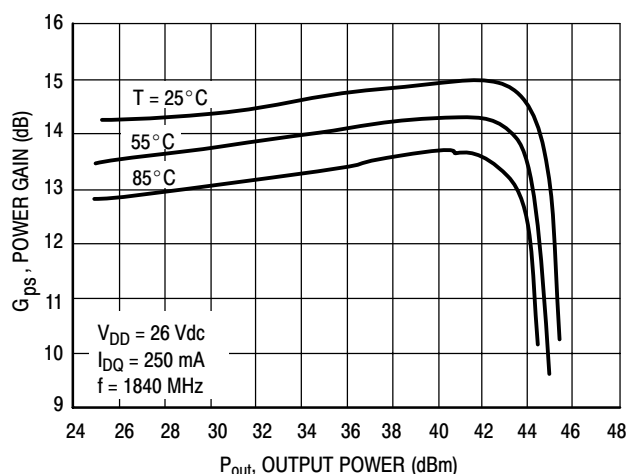


Figure 6. Power Gain versus Output Power

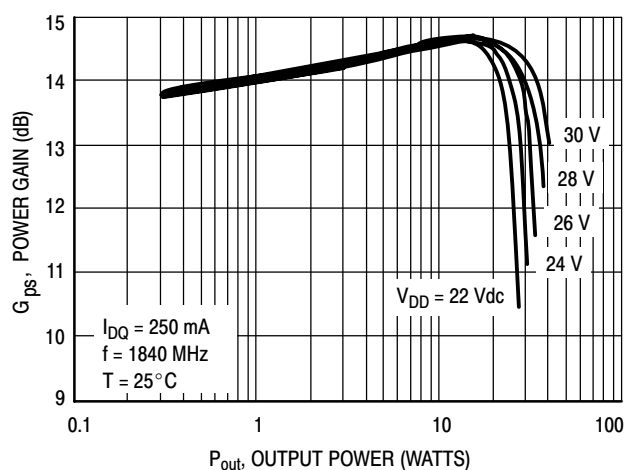


Figure 7. Power Gain versus Output Power

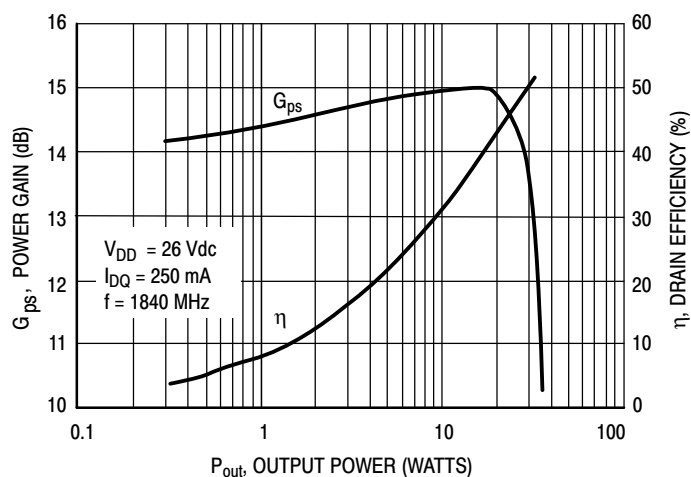
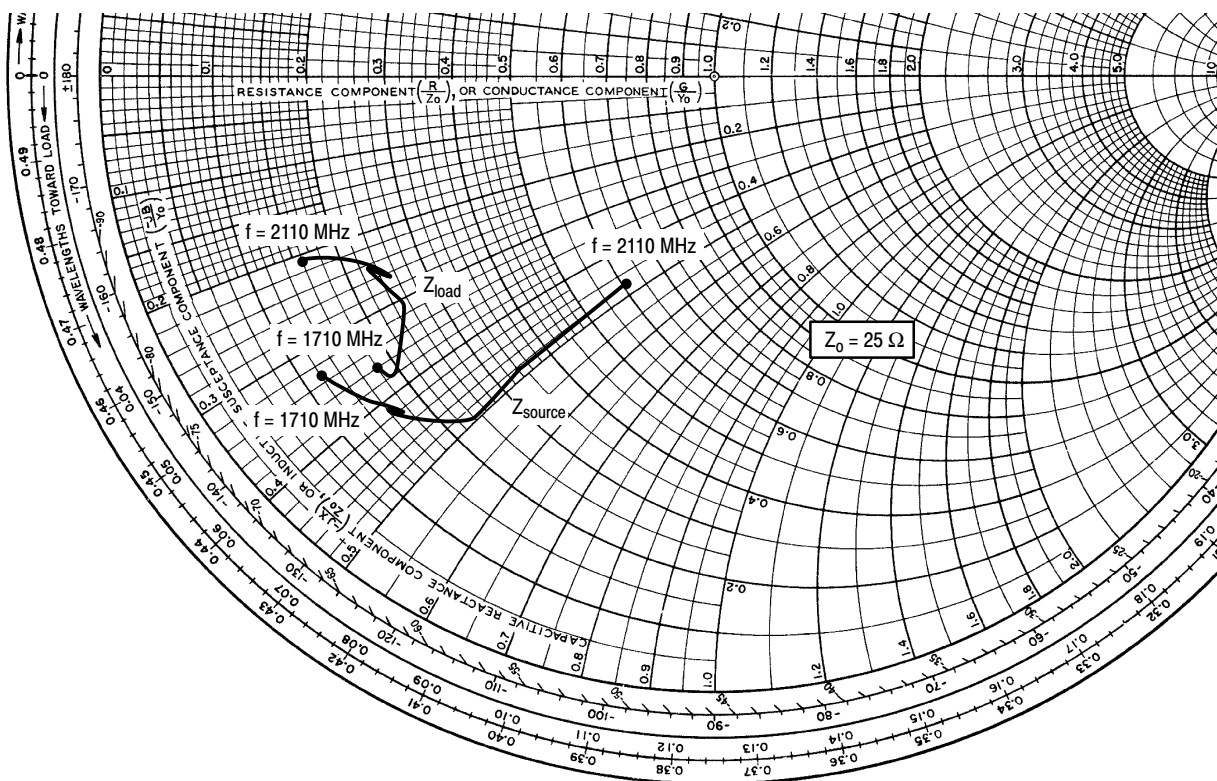


Figure 8. Power Gain and Efficiency versus Output Power

Freescale Semiconductor, Inc.



$V_{DD} = 26 \text{ V}$, $I_{DQ} = 250 \text{ mA}$, $P_{\text{out}} = 30 \text{ W (CW)}$

f MHz	Z_{source} Ω	Z_{load} Ω
1710	$2.92 - j8.24$	$4.18 - j9.06$
1785	$3.84 - j9.75$	$4.59 - j9.46$
1805	$4.15 - j10.38$	$4.98 - j9.06$
1840	$4.04 - j10.22$	$6.10 - j7.63$
1880	$6.12 - j12.29$	$5.83 - j6.89$
1960	$6.20 - j12.29$	$5.55 - j6.33$
1990	$8.61 - j12.10$	$5.93 - j6.66$
2110	$15.19 - j11.85$	$3.82 - j5.33$

Z_{source} = Test circuit impedance as measured from gate to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

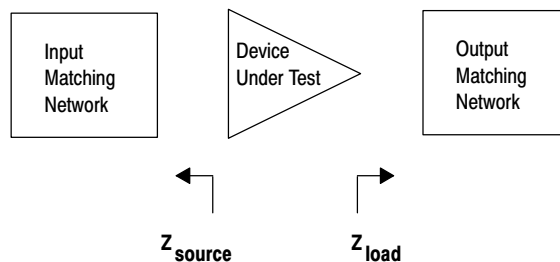
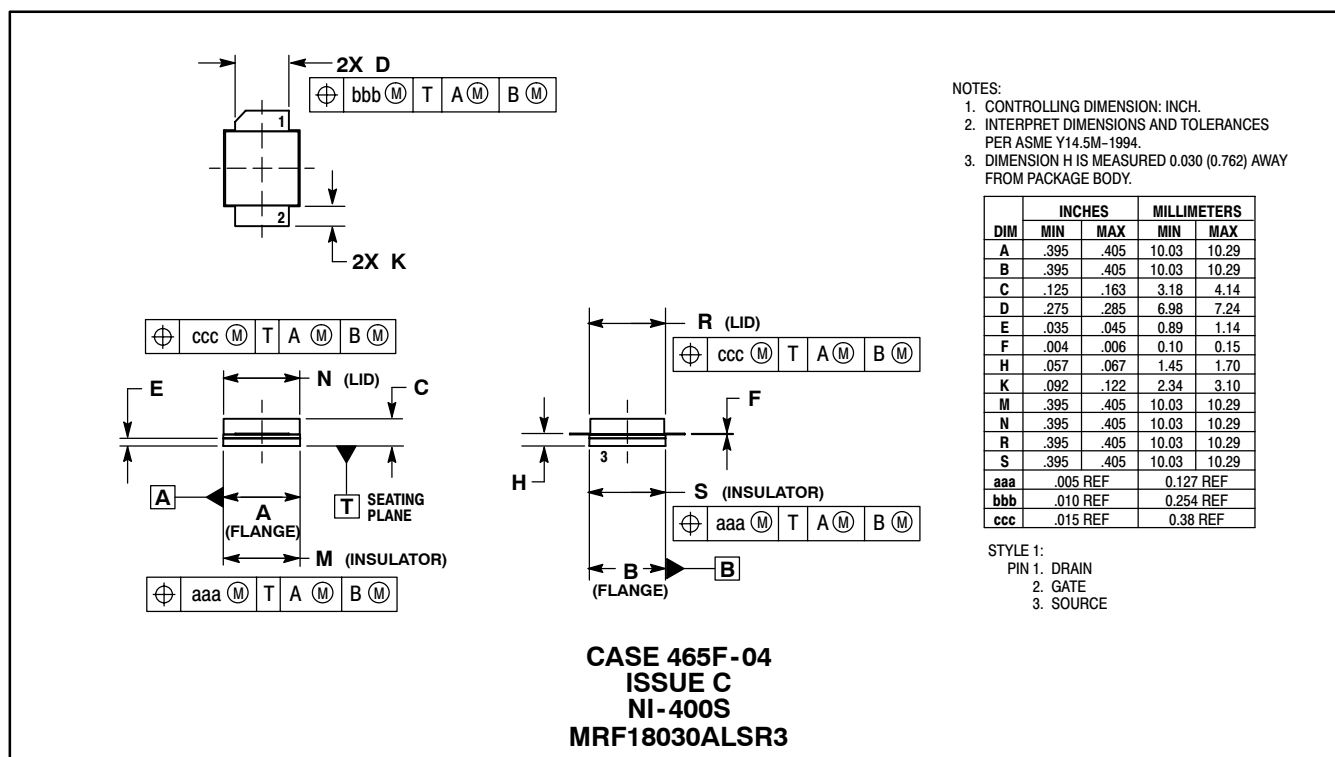
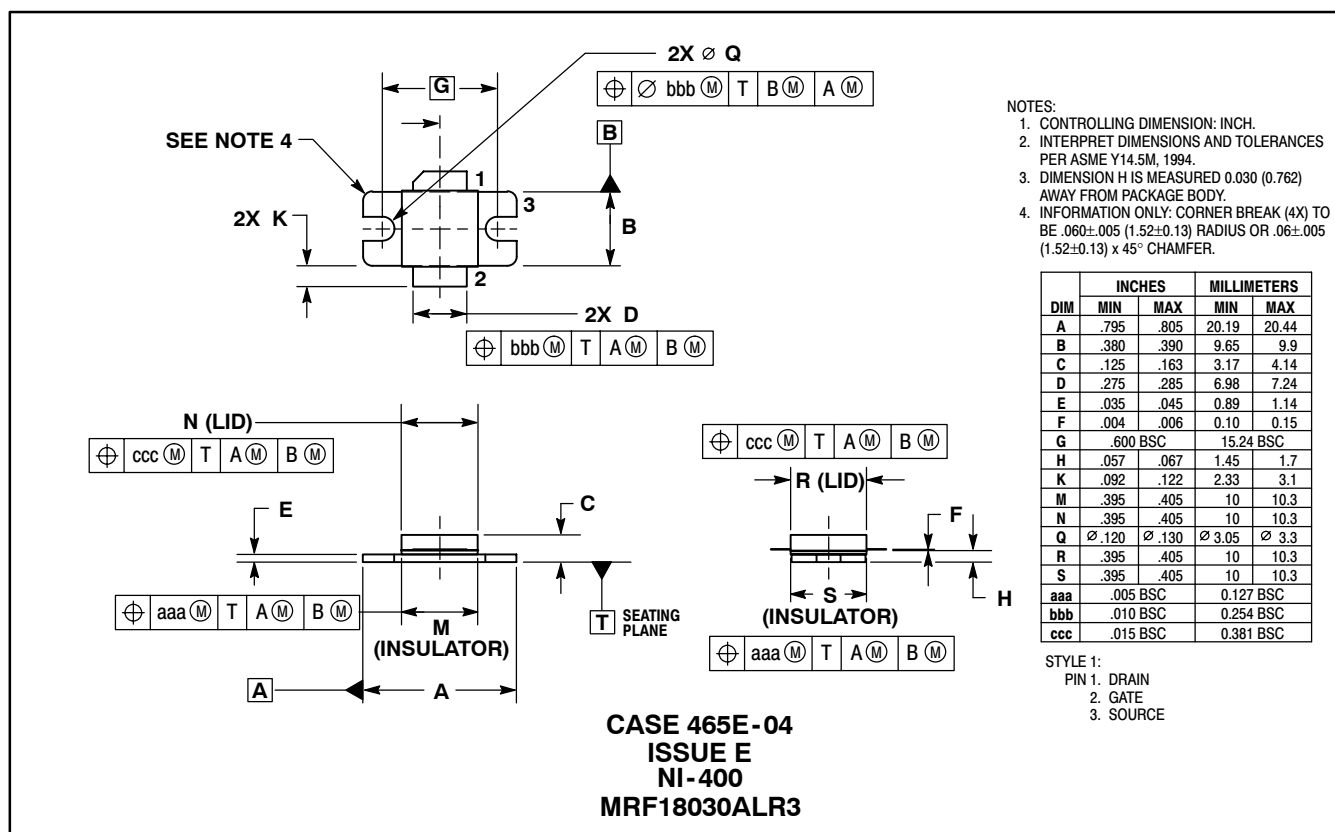


Figure 9. Series Equivalent Source and Load Impedance

NOTES

Freescale Semiconductor, Inc.

PACKAGE DIMENSIONS



Information in this document is provided solely to enable system and software implementers to use Motorola products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits or integrated circuits based on the information in this document.

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters that may be provided in Motorola data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals", must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part.

MOTOROLA and the Stylized M Logo are registered in the US Patent and Trademark Office. All other product or service names are the property of their respective owners. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

© Motorola Inc. 2004

HOW TO REACH US:

USA/EUROPE/LOCATIONS NOT LISTED:
Motorola Literature Distribution
P.O. Box 5405, Denver, Colorado 80217
1-800-521-6274 or 480-768-2130

JAPAN: Motorola Japan Ltd.; SPS, Technical Information Center,
3-20-1, Minami-Azabu, Minato-ku, Tokyo 106-8573, Japan
81-3-3440-3569

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; Silicon Harbour Centre,
2 Dai King Street, Tai Po Industrial Estate, Tai Po, N.T., Hong Kong
852-26668334

HOME PAGE: <http://motorola.com/semiconductors>



◇ **For More Information On This Product,
Go to: www.freescale.com**

MRF18030A/D